



(社)日本半導体製造装置協会

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2009年3月度BBレシオ (Book-to-Bill) (SEAJ速報値) 日本製半導体製造装置 (3ヶ月平均)

注意: データは3ヵ月移動平均です。

次回予定: SEAJ 4月度BBレシオ 5/21 16:00 SEAJ ホームページアップ予定

日本製の半導体製造装置の2009年3月度のBBレシオは0.30

東京 2009年4月17日 - 日本半導体製造装置協会が17日に発表した3月度の半導体製造装置速報値によると日本製装置(輸出を含む)の受注額は**13,551**百万円(3ヶ月移動平均)、BBレシオは**0.30**だった。BBレシオ0.30は100円で販売したのに対し30円の新たな受注があったことを示す。

受注額は前月比**0.9%**減(2009年2月度確定値は**13,680**百万円)、前年同月比**88.1%**減(2008年3月度は**113,471**百万円)の**13,551**百万円だった。

販売額は前月比**13.9%**増(2009年2月度確定値は**39,043**百万円)、前年同月比**71.3%**減(2008年3月度は**154,842**百万円)の**44,475**百万円だった。

※BBレシオの算出に当たっては、受注高、販売高の3ヶ月移動平均データを使用。単位:百万円

	販売 (3ヶ月平均)	受注 (3ヶ月平均)	BBレシオ
2008/10	74,856	60,913	0.81
2008/11	67,392	50,762	0.75
2008/12	48,960	34,047	0.70
2009/1	45,804	25,208	0.55
2009/2(確定値)	39,043	13,680	0.35
2009/3(暫定値)	44,475	13,551	0.30

本データは速報値(3ヶ月移動平均)です。確定値とは多少差異が生じる場合がありますのでご利用に際してはご注意ください。

なおSEMIは北米製の半導体製造装置のBBレシオ(3ヶ月移動平均の受注・販売比率)の速報を公表しています。

Web http://wps2a.semi.org/wps/portal/_pagr/135/_pa.135/677f

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March 2009 Book-to-Bill Ratio (Express Report)

Japan-based Semiconductor Manufacturing Equipment (3 Month Average)

Note : All data is based on three month average numbers.

Mark your calendars. **The April Report SEAJ's Web site update** is scheduled on **Thursday,21st May** approximately 4:00.P.M.Japan Time. Up dates are subject to change.

Japanese Semiconductor Equipment Industry Posts **March 2009 Book-to-Bill Ratio of 0.30**

Tokyo Japan., **April 17, 2009** -- JAPAN-based manufacturers of semiconductor equipment posted **¥13,551 million** in orders in **March 2009** (three-month average basis) and a BB Ratio of **0.30** according to the **March 2009 BB Ratio** published today by SEAJ. A book-to-bill ratio of **0.30** means that **¥30** worth of new orders was received for every **¥100** of product billed for the month.

The three-month average of worldwide bookings in **March 2009** was **¥13,551 million**. The bookings figure is **0.9 percent down the final February 2009** level of **¥13,680 million** and **88.1 percent down the ¥113,471 million** in orders posted in **March 2008**.

The three-month average of worldwide billings in **March 2009** was **¥44,475 million**. The billings figure is **13.9 percent up the final February 2009** level of **¥39,043 million** and **71.3 percent down the March 2008** billings level of **¥154,842 million**. The SEAJ book-to-bill is a ratio of three-month moving average bookings to three-month moving average billings for the Japanese semiconductor equipment industry. Billings and bookings figures are in millions of Japanese ¥.

	Billings (Three-month avg.)	Bookings (Three-month avg.)	Book-to-Bill Ratio
October 2008	74,856	60,913	0.81
November 2008	67,392	50,762	0.75
December 2008	48,960	34,047	0.70
January 2009	45,804	25,208	0.55
February 2009(final)	39,043	13,680	0.35
MArch 2009(prelim)	44,475	13,551	0.30

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Book-to-Bill Ratio published by SEAJ that tracks billings and bookings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings and orders of the chips themselves.

SEMI is released North American Semiconductor Manufacturing Equipment /Book-to-Bill Ratio(3 months Average) on Website. Web http://wps2a.semi.org/wps/portal/_pagr/135/_pa.135/677f

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